

# SGM8477-1/SGM8477-3 1.8V to 5.5V, Low Noise, Zero-Drift Difference Amplifiers

# GENERAL DESCRIPTION

The SGM8477-1/3 CMOS difference amplifiers provide very low offset voltage, low noise and zero-drift over time and temperature for precision differential signal processing.

The miniature, high-precision, low quiescent current amplifiers offer rail-to-rail input and output. Single or dual supplies as low as +1.8V ( $\pm0.9V$ ) and up to +5.5V ( $\pm2.75V$ ) may be used. It is optimized for low voltage operation.

SGM8477-1/3 are high performance amplifiers for accurate high-side and low-side current sensing, such as single battery voltage. SGM8477-3 can enter into shutdown status ( $I_Q < 0.5 \mu A$ ) when EN pin is logical "low", controlled by the external MCU.

Integrated matched resistors for differential application save external components. The SGM8477-1/3 have different versions for gains of 50 and 300.

The SGM8477-1 is available in Green SC70-6 and UTQFN-1.8×1.4-10L packages. The SGM8477-3 is available in Green UTQFN-1.8×1.4-10L package. They are all specified over -40°C to +125°C temperature range.

## **FEATURES**

Low Input Offset Voltage: 10μV (MAX)

Low Drift: 0.02µV/℃ (TYP)

Low 0.1Hz to 10Hz Noise: 250nV<sub>P-P</sub>
 Quiescent Current: 380µA (TYP)
 Shutdown Status Current: < 0.5µA</li>

Low Noise: 10nV/√Hz at 1kHz

• Integrated RFI Filter

• Single Supply Operation

• Supply Voltage Range: 1.8V to 5.5V

• Rail-to-Rail Input and Output

-40°C to +125°C Operating Temperature Range

 Small Packaging: SGM8477-1 is Available in Green SC70-6 and UTQFN-1.8×1.4-10L Packages SGM8477-3 is Available in Green UTQFN-1.8×1.4-10L Package

### **APPLICATIONS**

Transducer Applications
Temperature Measurements
Electronic Scales
Medical Instrumentation
Battery-Powered Instrument
Handheld Test Equipment



# PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM8477-1B	SC70-6	-40°C to +125°C	SGM8477-1BXC6G/TR	GI0XX	Tape and Reel, 3000
(Gain = 50)	UTQFN-1.8×1.4-10L	-40°C to +125°C	SGM8477-1BXUWQ10G/TR	I6XX	Tape and Reel, 3000
SGM8477-1G	SC70-6	-40°C to +125°C	SGM8477-1GXC6G/TR	GHFXX	Tape and Reel, 3000
(Gain = 300)	UTQFN-1.8×1.4-10L	-40°C to +125°C	SGM8477-1GXUWQ10G/TR	I4XX	Tape and Reel, 3000
SGM8477-3B (Gain = 50)	UTQFN-1.8×1.4-10L	-40°C to +125°C	SGM8477-3BXUWQ10G/TR	I7XX	Tape and Reel, 3000
SGM8477-3G (Gain = 300)	UTQFN-1.8×1.4-10L	-40°C to +125°C	SGM8477-3GXUWQ10G/TR	I5XX	Tape and Reel, 3000

NOTE: XX = Date Code.

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

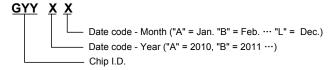
#### **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage	6V
Input Common Mode Voltage R	ange
	$(-V_S)$ - 0.3V to $(+V_S)$ + 0.3V
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (Soldering 1	0sec)+260°C
ESD Susceptibility	
HBM	4000V
MM	400V
CDM	1000V

# RECOMMENDED OPERATING CONDITIONS

Specified Voltage Range	1.8V to 5.5V
Operating Temperature Range	-40°C to +125°C

#### MARKING INFORMATION



For example: GI0FA (2015, January)

#### **OVERSTRESS CAUTION**

Stresses beyond those listed may cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the operational section of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

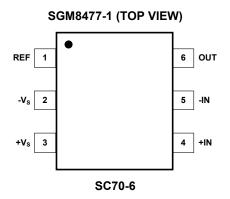
#### **ESD SENSITIVITY CAUTION**

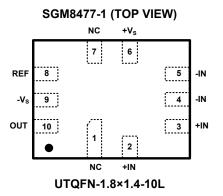
This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### **DISCLAIMER**

SG Micro Corp reserves the right to make any change in circuit design, specification or other related things if necessary without notice at any time.

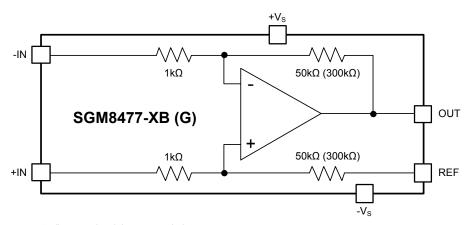
# **PIN CONFIGURATIONS**





# SGM8477-3 (TOP VIEW) EN +V<sub>S</sub> 7 6 REF 8 5 -IN -V<sub>S</sub> 9 4 -IN OUT 10 1 2 NC +IN UTQFN-1.8×1.4-10L

# **FUNCTIONAL BLOCK DIAGRAM**



"( )" ARE FOR SGM8477-XG ONLY.

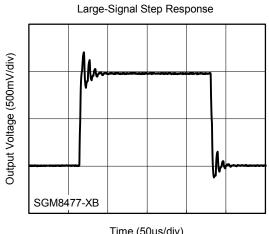
# **ELECTRICAL CHARACTERISTICS**

(At  $T_A$  = +25°C, +V<sub>S</sub> = 1.8V to 5.5V, -V<sub>S</sub> = 0V, V<sub>CM</sub> = +V<sub>S</sub>/2, V<sub>REF</sub> = +V<sub>S</sub>/2 and R<sub>L</sub> = 10k $\Omega$ , unless otherwise noted.)

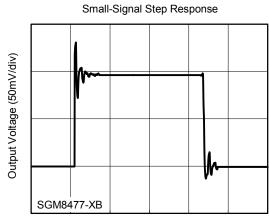
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
INPUT CHARACTERISTICS						
	+V <sub>S</sub> = 5V		3	10	/	
Input Offset Voltage (Vos)	40°C ≤ T <sub>A</sub> ≤ +125°C			12	μV	
Input Offset Voltage Drift (ΔV <sub>OS</sub> /ΔT)	-40°C ≤ T <sub>A</sub> ≤ +125°C		0.02		μV/°C	
Input Common Mode Voltage Range (V <sub>CM</sub> )		-V <sub>S</sub>		+V <sub>S</sub>	V	
	$(-V_S) < V_{CM} < (+V_S)$	89	108			
Common Mode Rejection Ratio (CMRR)	-40°C ≤ T <sub>A</sub> ≤ +85°C	84			dB	
	-40°C ≤ T <sub>A</sub> ≤ +125°C	58				
OUTPUT CHARACTERISTICS		'		•		
0.1.17.110.16	$R_L = 10k\Omega$		6	21	mV	
Output Voltage Swing from Rail	-40°C ≤ T <sub>A</sub> ≤ +125°C			23		
01 10: "0 11	+V <sub>S</sub> = 1.8V		12			
Short-Circuit Current (I <sub>SC</sub> )	+V <sub>S</sub> = 5V		50		mA	
POWER SUPPLY				1		
Specified Voltage Range (Vs)		1.8		5.5	V	
D 0 1 D : // D // (DODD)	+V <sub>S</sub> = 1.8V to 5.5V		1	4		
Power Supply Rejection Ratio (PSRR)	-40°C ≤ T <sub>A</sub> ≤ +125°C			6	μV/V	
Quiescent Current (I <sub>Q</sub> )	I <sub>O</sub> = 0, EN = 1.8V (active), +V <sub>S</sub> = 5V		380	530	μA	
	$I_0$ = 0, EN = 0V (shutdown), +V <sub>S</sub> = 5V, SGM8477-3 only		0.2	0.5		
Turn-On Time	+V <sub>S</sub> = 5V		100		μs	
DYNAMIC PERFORMANCE						
2dP Pandwidth (PM)	C <sub>L</sub> = 50pF, Gain = +50		150		kHz	
-3dB Bandwidth (BW <sub>-3</sub> )	C <sub>L</sub> = 50pF, Gain = +300		32		kHz	
Slow Pata (SP)	+V <sub>S</sub> = 5V, Gain = +50		0.4		1////	
Slew Rate (SR)	+V <sub>S</sub> = 5V, Gain = +300		0.15		V/µs	
NOISE						
Input Voltage Noise	f = 0.1Hz to 10Hz		250		nV <sub>P-P</sub>	
Input Voltage Noise Density (en)	f = 1kHz		10		nV/√Hz	
ENABLE CONTROL (SGM8477-3 ONLY)						
Input Logic High Voltage (V <sub>IH</sub> )		(-V <sub>S</sub> ) + 1.8			V	
Input Logic Low Voltage (V <sub>IL</sub> )				$(-V_S) + 0.4$	V	
EN Input Bias Current	$V_{EN} = +V_S$ or $V_{EN} = -V_S$	-0.4		0.4	μΑ	
GAIN	•				•	
Octo Farm	$(-V_S) + 0.1V \le V_{OUT} \le (+V_S) - 0.1V$ , Gain = +50	0.01		0.2	%	
Gain Error	$(-V_S) + 0.1V \le V_{OUT} \le (+V_S) - 0.1V$ , Gain = +300		0.01	0.3	%	
Onlin Townson there On W	$(-V_S) + 0.1V \le V_{OUT} \le (+V_S) - 0.1V$ , Gain = +50		2		ppm/°C	
Gain Temperature Coefficient	$(-V_S) + 0.1V \le V_{OUT} \le (+V_S) - 0.1V$ , Gain = +300		7		ppm/°C	

# TYPICAL PERFORMANCE CHARACTERISTICS

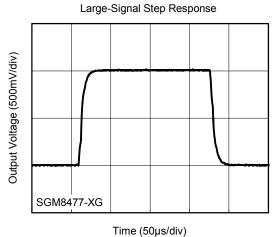
 $+V_S = 5V$ ,  $T_A = +25$ °C, unless otherwise noted.

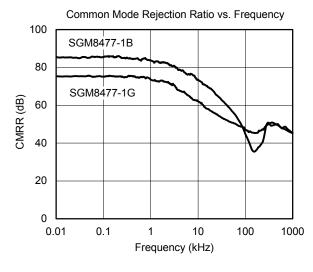


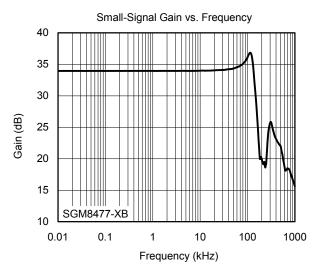


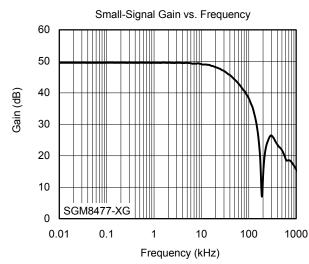


Time (50µs/div)



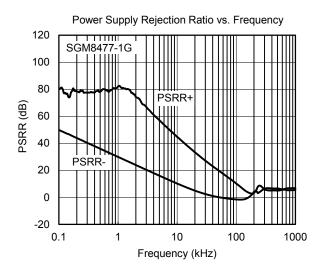


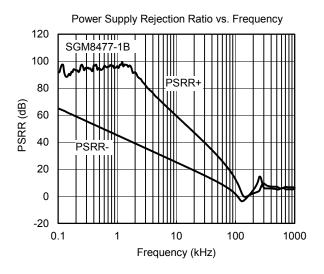


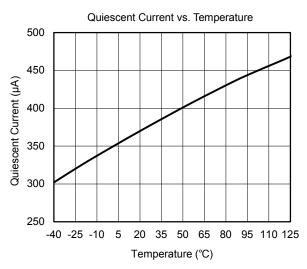


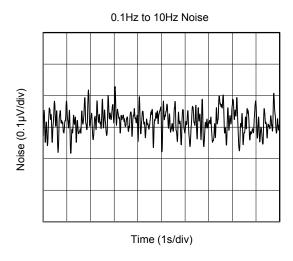
# **TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

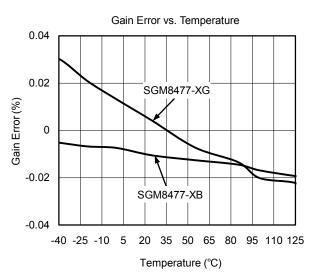
 $+V_S = 5V$ ,  $T_A = +25$ °C, unless otherwise noted.

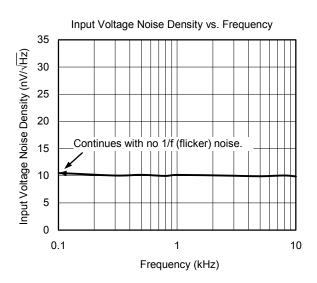






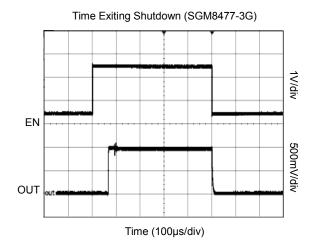


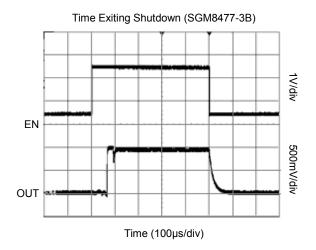




# **TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

 $+V_S = 5V$ ,  $T_A = +25$ °C, unless otherwise noted.





# APPLICATION INFORMATION

The SGM8477-1/3 provide low offset voltage and very low drift over time and temperature. For lowest offset voltage and precision performance, circuit layout and mechanical conditions should be optimized. Avoid temperature gradients that create thermoelectric (Seebeck) effects in the thermocouple junctions formed from connecting dissimilar conductors. These thermally-generated potentials can be made to cancel by assuring they are equal on both input terminals. Other layout and design considerations include:

- Use low thermoelectric-coefficient conditions (avoid dissimilar metals).
- Thermally isolate components from power supplies or other heat sources.
- Shield difference amplifier and input circuitry from air currents, such as cooling fans.

Following these guidelines will reduce the likelihood of junctions being at different temperatures, which can cause thermoelectric voltages of  $0.02\mu\text{V/°C}$  or higher, depending on materials used.

# **Operating Voltage**

The SGM8477-1/3 difference amplifiers operate over a power supply range of  $\pm 1.8V$  to  $\pm 5.5V$  (or  $\pm 0.9V$  to  $\pm 2.75V$ ). Supply voltages higher than  $\pm 6V$  (absolute maximum) can permanently damage the device.

### **Enable Control**

For SGM8477-3, if EN pin is floating or logical "high", SGM8477-3 is in active status; when EN pin is logical "low", SGM8477-3 will enter into shutdown status.

## **General Layout Guidelines**

Attention to good layout practices is always recommended. Keep traces short and, when possible, use a printed circuit board (PCB) ground plane with surface-mount components placed as close to the device pins as possible. Place a 0.1µF capacitor closely across the supply pins. These guidelines should be applied throughout the analog circuit to improve performance and provide benefits such as reducing the EMI (electromagnetic-interference) susceptibility. Difference amplifiers vary in their susceptibility to radio frequency interference (RFI). RFI can generally be identified as a variation in offset voltage or DC signal levels with changes in the interfering RF signal. The SGM8477-1/3 have been specifically designed to minimize susceptibility to RFI and demonstrate remarkably low sensitivity. Strong RF fields may still cause varying offset levels. The circuit in Figure 1 is for thermocouple signal condition.

A low-side current shunt monitor is shown in Figure 2.  $R_N$  are operational resistors used to isolate the ADC from the noise of the digital  $I^2C$  bus. Since the ADC is a 16-bit converter, a precision reference is essential for maximum accuracy. Related application circuits are shown in Figures  $3 \sim 4$ .

# **APPLICATION INFORMATION (continued)**

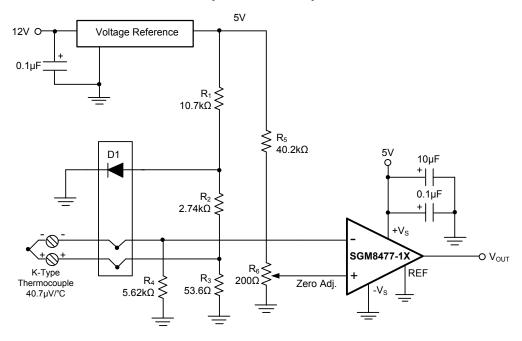


Figure 1. Thermocouple Temperature Measuring Circuit

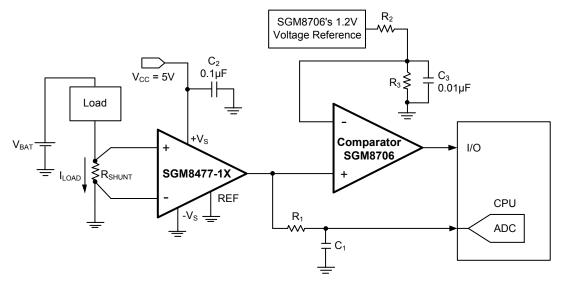
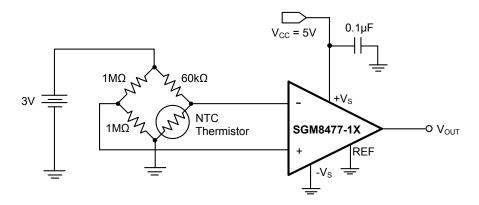


Figure 2. Accurate Low-side Current Sensing

# **APPLICATION INFORMATION (continued)**



**Figure 3. Thermistor Measurement** 

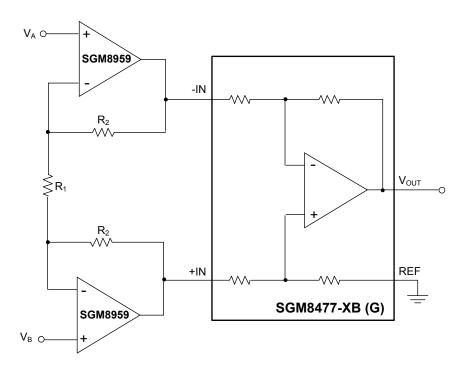


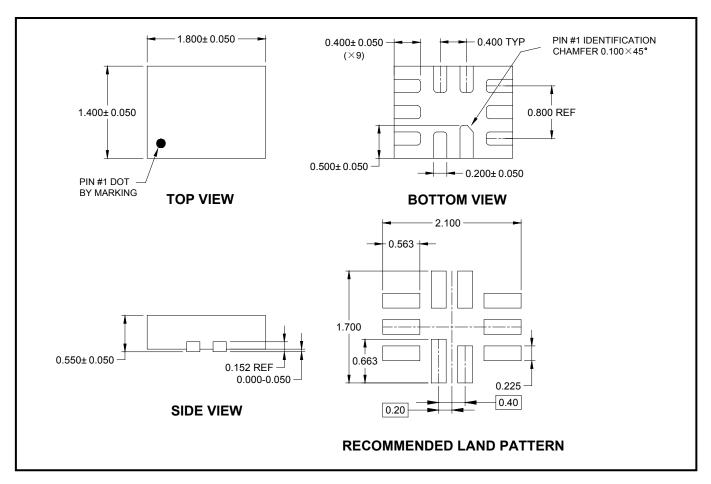
Figure 4. Precision Instrumentation Amplifier

# **REVISION HISTORY**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

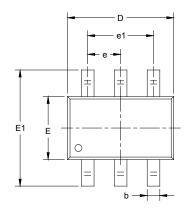
Changes from Original (MAY 2017) to REV.A

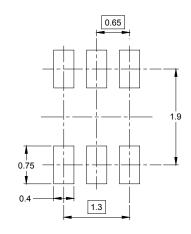
# PACKAGE OUTLINE DIMENSIONS UTQFN-1.8×1.4-10L



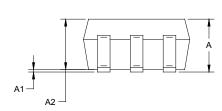
NOTE: All linear dimensions are in millimeters.

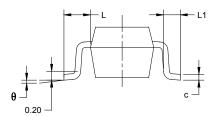
# PACKAGE OUTLINE DIMENSIONS SC70-6





RECOMMENDED LAND PATTERN (Unit: mm)

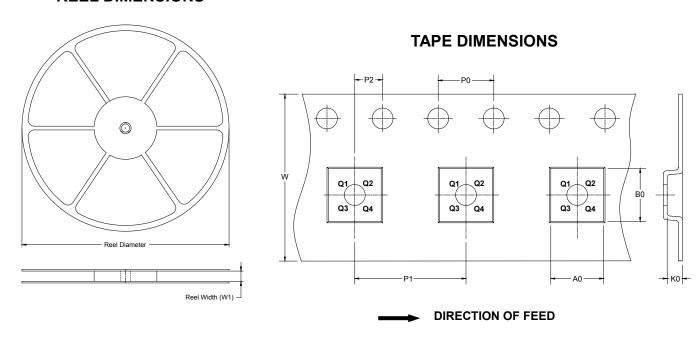




Symbol		nsions meters	Dimensions In Inches		
	MIN	MAX	MIN	MAX	
Α	0.900	1.100	0.035	0.043	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.000	0.035	0.039	
b	0.150	0.350	0.006	0.014	
С	0.080	0.150	0.003	0.006	
D	2.000	2.200	0.079	0.087	
E	1.150	1.350	0.045	0.053	
E1	2.150	2.450	0.085	0.096	
е	0.65 TYP		0.026 TYP		
e1	1.300 BSC		0.051 BSC		
L	0.525 REF		0.021 REF		
L1	0.260	0.460	0.010	0.018	
θ	0°	8°	0°	8°	

# TAPE AND REEL INFORMATION

# **REEL DIMENSIONS**

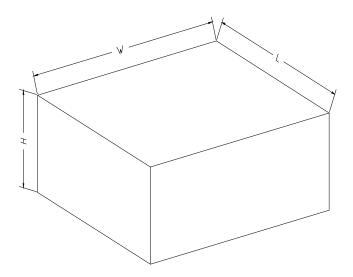


NOTE: The picture is only for reference. Please make the object as the standard.

# **KEY PARAMETER LIST OF TAPE AND REEL**

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
UTQFN-1.8×1.4-10L	7"	9.0	1.75	2.10	0.70	4.0	4.0	2.0	8.0	Q1
SC70-6	7"	9.5	2.40	2.50	1.20	4.0	4.0	2.0	8.0	Q3

# **CARTON BOX DIMENSIONS**



NOTE: The picture is only for reference. Please make the object as the standard.

# **KEY PARAMETER LIST OF CARTON BOX**

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18